

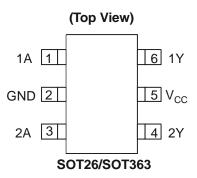
#### **Description**

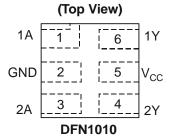
The 74LVC2G34 is a dual buffer gate with standard push pull outputs. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using  $I_{\rm OFF}$ . The  $I_{\rm OFF}$  circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

$$Y = A$$

#### **Pin Assignments**





#### **Features**

- Wide Supply Voltage Range from 1.65V to 5.5V
- ±24mA Output Drive at 3.0V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Tested per JESD 22
  - o Exceeds 200-V Machine Model (A115-A)
  - o Exceeds 2000-V Human Body Model (A114-A)
  - o Exceeds 1000-V Charged Device Model (C101)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Range of Package Options
- SOT26, SOT363, and DFN1010 Available in "Green" Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

#### **Applications**

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as:
  - PCs, networking, notebooks, netbooks, PDAs
  - o Computer peripherals, hard drives, CD/DVD ROM
  - o TV, DVD, DVR, set top box
  - o Cell Phones, Personal Navigation / GPS
  - o MP3 players ,Cameras, Video Recorders

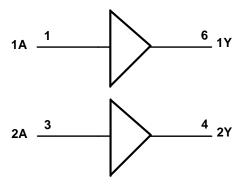
Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead\_free.html.



## **Pin Descriptions**

Pin Name	Pin NO.	Description			
1A	1	Data Input			
GND	2	Ground			
2A	3	Data Input			
2Y	4	Data Output			
V <sub>CC</sub>	5	Supply Voltage			
1Y	6	Data Output			

# Logic Diagram



### **Function Table**

Inputs	Output
Α	Υ
Н	Н
L	L



### **Absolute Maximum Ratings (Note 2)**

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
$V_{CC}$	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	٧
Vo	Voltage applied to output in high impedance or I <sub>OFF</sub> state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state.	-0.3 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	Input Clamp Current V <sub>I</sub> <0	-50	mA
l <sub>OK</sub>	Output Clamp Current	-50	mA
Io	Continuous output current	±50	mA
	Continuous current through Vdd or GND	±100	mA
TJ	Operating Junction Temperature	-40 to 150	°C
T <sub>STG</sub>	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

### **Recommended Operating Conditions (Note 3)**

Symbol		Parameter	Min	Max	Unit
V	Operating Valtage	Operating	1.65	5.5	V
$V_{CC}$	Operating Voltage	Data retention only	1.5		V
		$V_{CC} = 1.65V \text{ to } 1.95V$	0.65 X V <sub>CC</sub>		
V	High lovel Input Voltage	$V_{CC} = 2.3V \text{ to } 2.7V$	1.7		V
$V_{IH}$	High-level Input Voltage	$V_{CC} = 3V$ to 3.6V	2		V
		$V_{CC} = 4.5V \text{ to } 5.5V$	0.7 X V <sub>CC</sub>		
		V <sub>CC</sub> = 1.65V to 1.95V		0.35 X V <sub>CC</sub>	
\ <i>/</i>	Low-level input voltage	$V_{CC} = 2.3V \text{ to } 2.7V$		0.7	\/
$V_{IL}$		$V_{CC} = 3V \text{ to } 3.6V$		0.8	V
		V <sub>CC</sub> = 4.5V to 5.5V		0.3 X V <sub>CC</sub>	
VI	Input Voltage	•	0	5.5	V
Vo	Output Voltage		0	V <sub>CC</sub>	V
		V <sub>CC</sub> = 1.65V		-4	
		V <sub>CC</sub> = 2.3V		-8	
$I_{OH}$	High-level output current	V <sub>CC</sub> = 3V		-16	mA
		VCC = 3V		-24	
		$V_{CC} = 4.5V$		-32	
		$V_{CC} = 1.65V$		4	
		$V_{CC} = 2.3V$		8	
$I_{OL}$	Low-level output current	V <sub>CC</sub> = 3V		16	mA
		vCC = 2v		24	
		$V_{CC} = 4.5V$		32	



## **Recommended Operating Conditions (cont.) (Note 3)**

Symbol		Parameter	Min	Max	Unit
	land the side a size of all	$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$		20	
Δt/ΔV	Input transition rise or fall	$V_{CC} = 3.3V \pm 0.3V$		10	ns/V
	rate	$V_{CC} = 5V \pm 0.5V$		5	
T <sub>A</sub>	Operating free-air temperature		-40	125	°C

Notes: 3. Unused inputs should be held at  $V_{CC}$  or Ground.

#### **Electrical Characteristics**

		T 0 I'd	N/	40°C to	o 85ºC	-40°C to	125°C		
Symbol	Parameter	Test Conditions	V <sub>CC</sub>	Min	Max	Min	Max	Unit	
		I <sub>OH</sub> = -100μA	1.65V to 5.5V	V <sub>CC</sub> – 0.1		V <sub>CC</sub> - 0.1			
		$I_{OH} = -4mA$	1.65V	1.2		0.95			
\/	High Level Output	$I_{OH} = -8mA$	2.3V	1.9		1.7		V	
V <sub>OH</sub>	Voltage	I <sub>OH</sub> = -16mA	3V	2.4		1.9		V	
		$I_{OH} = -24mA$	3V	2.3		2.0			
		$I_{OH} = -32mA$	4.5V	3.8		3.4			
	Low Level Output Voltage	$I_{OL} = 100 \mu A$	1.65V to 5.5V		0.1		0.1		
		I <sub>OL</sub> = 4mA	1.65V		0.45		0.70		
\/		$I_{OL} = 8mA$	2.3V		0.3		0.45	V	
V <sub>OL</sub>		I <sub>OL</sub> = 16mA	2)/		0.4		0.60	V	
		$I_{OL} = 24mA$	- 3V		0.55		0.80		
		$I_{OL} = 32mA$	4.5V		0.55		0.80		
II	Input Current	$V_I = 5.5 \text{ V or GND}$	0 to 5.5V		± 5		± 20	μA	
l <sub>OFF</sub>	Power Down Leakage Current	$V_I$ or $V_O = 5.5V$	0		± 10		± 20	μΑ	
I <sub>CC</sub>	Supply Current	$V_I = 5.5V$ of GND $I_{O}=0$	1.65V to 5.5V		10		40	μΑ	
ΔI <sub>CC</sub>	Additional Supply Current	Input at V <sub>CC</sub> –0.6V	3V to 5.5V		500		5000	μΑ	



# Package Characteristics (All typical values are at $V_{CC} = 3.3V$ , $T_A = 25$ °C)

Symbol	Parameter	Test Conditions	V <sub>CC</sub>	Min	Тур.	Max	Unit	
C <sub>I</sub>	Input Capacitance	$V_I = V_{CC} - \text{or GND}$	3.3		4		рF	
	The man all Decisters as	SOT26			204			
$\theta_{JA}$	Thermal Resistance Junction-to-Ambient	SOT363	(Note 4)		371		°C/W	
		DFN1010			430			
	The man all Decisters as	SOT26			52			
$\theta_{JC}$	Thermal Resistance Junction-to-Case	SOT363	(Note 4)		143		°C/W	
	Junction-to-Case	DFN1010			190			

Notes:

## **Switching Characteristics**

 $T_A = -40$ °C to 85°C, CL = 30 or 50pF (see Figure 1)

Parameter	Parameter From TO (Input) (OUTPUT		V <sub>CC</sub> = 1.8V ± 0.15V					V <sub>CC</sub> = 3.3V ± 0.3V		V <sub>CC</sub> = 5V ± 0.5V	
		(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>pd</sub>	Α	Υ	0.5	8.6	0.5	4.4	0.5	4.1	0.5	3.2	ns

 $T_A = -40 \text{ °C to } 125 \text{ °C}, CL = 30 \text{ or } 50pF$  (see Figure 1)

Parameter	meter From TO	V <sub>CC</sub> = 1.8V ± 0.15V		V <sub>CC</sub> = 2.5V ± 0.2V		V <sub>CC</sub> = 3.3V ± 0.3V		V <sub>CC</sub> = 5V ± 0.5V		Unit	
	(Input)	(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>pd</sub>	Α	Υ	0.5	10.8	0.5	5.5	0.5	5.1	0.5	4.0	ns

### **Operating Characteristics**

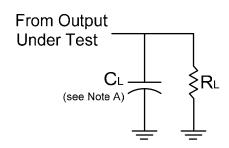
 $T_A = 25^{\circ}C$ 

	Parameter		V <sub>CC</sub> = 1.8V Typ.	V <sub>CC</sub> = 2.5V Typ.	V <sub>CC</sub> = 3.3V Typ.	V <sub>CC</sub> = 5V Typ.	Unit
C <sub>pd</sub>	Power dissipation capacitance	f = 10 MHz	17	19	20	21	pF

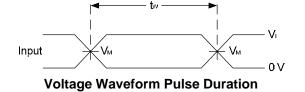
<sup>4.</sup> Test condition for SOT26, SOT363 and DFN1010 : Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

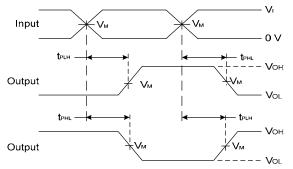


#### **Parameter Measurement Information**



V	Inputs		V	C	R <sub>L</sub>	
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	CL	ΝĹ	
1.8V±0.15V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	30 pF	1 ΚΩ	
2.5V±0.2V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	30 pF	500 Ω	
3.3V±0.3V	3 V	≤2.5ns	1.5 V	50 pF	500 Ω	
5V±0.5V	V <sub>CC</sub>	≤2.5ns	V <sub>CC</sub> /2	50 pF	500 Ω	





Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1. Load Circuit and Voltage Waveforms

Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>PD</sub>.



### **Ordering Information**

74LVC 2G 34 XX - 7 Logic Device **Function** Package Packing 74: Logic Prefix 34: Buffer/Driver W6: SOT26 7: Tape & Reel

**DW: SOT363** LVC: 1.65 to 5.5V FW4: DFN1010 Family

2G: Two gates

	Dovice	Device Package Packaging Code (Note 5)		7" Tape and Reel			
	Device			Quantity	Part Number Suffix		
Pb	74LVC2G34W6-7	W6	SOT26	3000/Tape & Reel	-7		
<b>Pb</b>	74LVC2G34DW-7	DW	SOT363	3000/Tape & Reel	-7		
<b>Pb</b> ,	74LVC2G34FW4-7	FW4	DFN1010	5000/Tape & Reel	-7		

Notes:

- 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf
- 6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf

### **Marking Information**

#### (1) SOT26, SOT363

5 4 XX: Identification code Y: Year 0~9 XXYWX W: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents 52 and 53 week X: A~Z: Internal Code 2

Part Number	Package	Identification Code
74LVC2G34W6	SOT26	<b>Z</b> 7
74LVC2G34DW	SOT363	Z7

#### (2) DFN1010

#### (Top View)

YWX XX: Identification Code Ÿ : Year : 0~9

<u>W</u>: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents

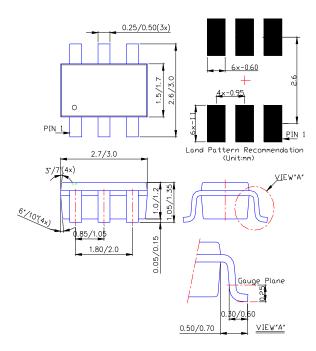
52 and 53 week X: A~Z: Internal code

Part Number	Package	Identification Code
74LVC2G34FW4	DFN1010	<b>Z</b> 7

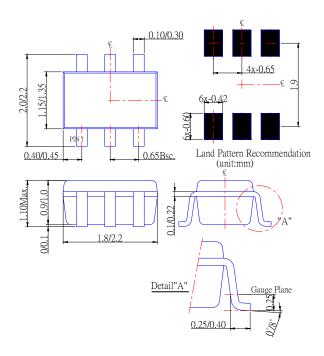


### Package Outline Dimensions (All Dimensions in mm)

#### (1) Package Type: SOT26



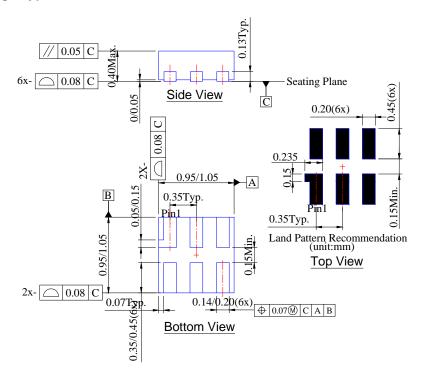
#### (2) Package Type: SOT363





### Package Outline Dimensions (All Dimensions in mm)

#### (3) Package Type: DFN1010





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